APPENDIX A ELECTRICAL CHARACTERISTICS

Table A-1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|--|------------------|---|------|
| Supply Voltage | V _{DD} | - 0.3 to + 7.0 | ٧ |
| Input Voltage | Vin | - 0.3 to + 7.0 | ٧ |
| Operating Temperature Range MC68HC(7)11ExC MC68HC(7)11ExV MC68HC(7)11ExV MC68HC(7)11ExM MC68HC811E2 MC68HC811E2C MC68HC811E2V MC68HC811E2V MC68HC811E2M MC68HC811E2M | TA | T _L to T _H 0 to + 70 - 40 to + 85 - 40 to + 105 - 40 to + 125 0 to + 70 - 40 to + 85 - 40 to + 105 - 40 to + 105 - 40 to + 125 - 20 to + 70 | °C |
| Storage Temperature Range | T _{stg} | - 55 to + 150 | °C |
| Current Drain per Pin* Excluding V _{DD} , V _{SS} , AV _{DD} , V _{RH} , and V _{RL} | ID | 25 | mA |

^{*}One pin at a time, observing maximum power dissipation limits.

Internal circuitry protects the inputs against damage caused by high static voltages or electric fields; however, normal precautions are necessary to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Extended operation at the maximum ratings can adversely affect device reliability. Tying unused inputs to an appropriate logic voltage level (either GND or V_{DD}) enhances reliability of operation.

Table A-2. Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|---|----------|--------|---|------|
| Average Junction Temperature | | TJ | $T_A + (P_D \times \Theta_{JA})$ | °C |
| Ambient Temperature | | TA | User-determined | °C |
| Package Thermal Resistance (Junction- 48-Pin Plastic DIP (MC68HC811E2 of 56-Pin Plastic SDIP 52-Pin Plastic Leaded Chip Carrier 52-Pin Plastic Thin Quad Flat Pack (64-Pin Quad Flat Pack | only) | ⊖ЈА | 50 50 50 85 85 | *C/W |
| Total Power Dissipation | (Note 1) | PD | P _{INT} + P _{I/O} K / (T _J + 273°C) | w |
| Device Internal Power Dissipation | | PINT | I _{DD} × V _{DD} | W |
| I/O Pin Power Dissipation | (Note 2) | Pivo | User-determined | w |
| A Constant | (Note 3) | к | P _D ×(T _A +273°C)+ _{GJA} ×P _D ² | W.ªC |

NOTES:

- 1. This is an approximate value, neglecting PI/O.
- For most applications P_{I/O}
 « P_{INT} and can be neglected.
- K is a constant pertaining to the device. Solve for K with a known T_A and a measured P_D (at equilibrium).
 Use this value of K to solve for P_D and T_J iteratively for any value of T_A.

M68HC11 E SERIES TECHNICAL DATA APPENDIX A ELECTRICAL CHARACTERISTICS MOTOROLA

Table A-3. DC Electrical Characteristics

 $V_{DD} = 5.0 \text{ Vdc} \pm 10\%$, $V_{SS} = 0 \text{ Vdc}$, $T_A = T_L \text{ to } T_H$, unless otherwise noted

| Characteristics | Symbol | Min | Max | Unit |
|--|-----------------------------------|--|--|--------------------------|
| Output Voltage (Note 1) All Outputs except XTAL All Outputs Except XTAL, RESET, and MODA I _{Load} = ± 10.0 μA | V _L V _{OH} | V _{DD} - 0.1 | 0.1 | ٧ |
| Output High Voltage (Note 1) All Outputs Except XTAL, RESET, and MODA I _{Load} = -0.8 mA, V _{DD} = 4.5 V | Voн | V _{DO} - 0.8 | _ | ٧ |
| | + ,, | | | |
| Output Low Voltage All Outputs Except XTAL ILoad = 1.6 mA | VoL | _ | 0.4 | v |
| Input High Voltage All Inputs Except RESET RESET | ViH | 0.7 × V _{DD} 0.8 × V _{DD} | V _{DD} + 0.3 V _{DD} + 0.3 | ٧ |
| Input Low Voltage All Inputs | V _{IL} | V _{SS} - 0.3 | 0.2 × V _{DD} | ٧ |
| I/O Ports, Three-State Leakage PA7, PA3, PC[7:0], PD[5:0], AS/STRA, Vin = V _{IH} or V _{IL} MODA/LIR, RESET | loz | _ | ±10 | μА |
| Input Leakage Current (Note 2) V _{in} = V _{DD} or V _{SS} PA[2:0], IRQ, XIRQ V _{in} = V _{DD} or V _{SS} MODB/V _{STBY} | lin | | ±1 ±10 | μ Α μ Α |
| RAM Standby Voltage Power down | V _{SB} | 4.0 | V _{DD} | ٧ |
| RAM Standby Current Power down | IsB | | 10 | μА |
| Input Capacitance PA[2:0], PE[7:0], IRQ, XIRQ, EXTAL PA7, PA3, PC[7:0], PD[5:0], AS/STRA, MODA/LIR, RESET | Cin | = | 8 12 | pF pF |
| Output Load Capacitance All Outputs Except PD[4:1] PD[4:1] | Q. | = | 90 100 | pF pF |
| Maximum Total Supply Current (Note 3) RUN: | IDD | | | |
| Single-Chip Mode 2 MHz 3 MHz | "55 | _ | 15 27 | mA mA |
| Expanded Multiplexed Mode 2 MHz | | _ | 27 | mA |
| 3 MHz WAIT: (All Peripheral Functions Shut Down) | WIDD | _ | 35 | mA. |
| Single-Chip Mode 2 MHz 3 MHz | **100 | _ | 6 15 | mA mA |
| Expanded Multiplexed Mode 2 MHz 3 MHz | | = | 10 20 | mA mA |
| STOP: | SIDD | | | |
| Single-Chip Mode, No Clocks - 40 to + 85 > + 85 to + 105 > +105 to + 125 | | = | 25 50 100 | μА |
| Maximum Power Dissipation | PD | | | |
| Single-Chip Mode 2 MHz 3 MHz | | | 85 150 | Wm Wm |
| Expanded Multiplexed Mode 2 MHz 3 MHz | | _ | 150 195 | Wm |

NOTES:

- 1. VOH specification for RESET and MODA is not applicable because they are open-drain pins. VOH specification not applicable to ports C and D in wired-OR mode.
- 2. Refer to A/D specification for leakage current for port E.
- 3. EXTAL is driven with a square wave, and

 t_{cyc} = 500 ns for 2 MHz rating; t_{cyc} = 333 ns for 3 MHz rating; $V_{IL} \le 0.2 \text{ V}$;

VIH ≥ VDD - 0.2 V; No dc loads.

MOTOROLA A-2

APPENDIX A **ELECTRICAL CHARACTERISTICS**

Table A-3a. DC Electrical Characteristics (MC68L11E9)

 $V_{DD} = 3.0 \text{ Vdc}$ to 5.5 Vdc, $V_{SS} = 0 \text{ Vdc}$, $T_A = T_L$ to T_H , unless otherwise noted

| Cha | racteristic | Symbol | Min | Max | Unit |
|---|--|------------------------------------|--|--|--------------------------|
| Output Voltage (Note 1) All Outputs I ILoad = ± 10.0 μA | All Outputs except XTAL Except XTAL, RESET, and MODA | V _{OL} V _{OH} | V _{DD} = 0.1 | 0.1 | V |
| Output High Voltage (Note 1 $I_{LOBd} = -0.5$ mA, $V_{DD} = I_{LOBd} = -0.8$ mA, $V_{DD} = -0.8$ | RESET, and MODA | VoH | V _{DD} - 0.8 | _ | V |
| Output Low Voltage I _{Load} = 1.6 mA, V _{DD} = 5 I _{Load} = 1.0 mA, V _{DD} = 3 | All Outputs Except XTAL 5.0 V | VOL | _ | 0.4 | V |
| Input High Voltage | All Inputs Except RESET | ViH | 0.7 × V _{DD} 0.8 × V _{DD} | V _{DD} + 0.3 V _{DD} + 0.3 | V |
| Input Low Voltage | All Inputs | VL | V _{SS} - 0.3 | $0.2 \times V_{DD}$ | ٧ |
| I/O Ports, Three-State Leak $V_{in} = V_{iH} \text{ or } V_{iL}$ | PA7, PA3, PC[7:0], PD[5:0], AS/STRA, MODA/LIR, RESET | loz | _ | ±10 | μА |
| Input Leakage Current (Note V _{in} = V _{DD} or V _{SS} V _{in} = V _{DD} or V _{SS} | PA[2:0], IRQ, XIRQ MODB/V _{STBY} | lin | _ | ±1 ±10 | μ Α μ Α |
| RAM Standby Voltage | Power down | VsB | 2.0 | V _{DD} | ٧ |
| RAM Standby Current | Power down | ISB | _ | 10 | μA |
| Input Capacitance PA[| 2:0], PE[7:0], IRQ, XIRQ, EXTAL PA7, PA3, PC[7:0], PD[5:0], AS/STRA, MODA/LIR, RESET | C _{in} | = | 8 12 | pF pF |
| Output Load Capacitance | All Outputs Except PD[4:1] PD[4:1] | ٩ | = | 90 100 | pF pF |

| Characteristic | | Symbol | 1 MHz | 2 MHz | Unit |
|---------------------------------------|--------------------------------|------------------|-------|-------|-------|
| Maximum Total Supply Current (Note 3) | | | | | |
| RUN: | | IDD | | | |
| Single-Chip Mode | $V_{DD} = 5.5 \text{ V}$ | | 8 | 15 | mA |
| | $V_{DD} = 3.0 \text{ V}$ | | 4 | 8 | mA. |
| Expanded Multiplexed Mode | V _{DD} = 5.5 V | | 14 | 27 | mA |
| | V _{DO} = 3.0 V | | 7 | 14 | mA. |
| WAIT: (All Peripheral Functions Shut | | W _{IDD} | • | | **** |
| Single-Chip Mode | V _{DD} = 5.5 V | | 3 | 6 | mA |
| omigic on princes | V _{DD} = 3.0 V | | 1.5 | 6 3 | mA |
| Expanded Multiplexed Mode | $V_{DD} = 5.5 \text{ V}$ | | 5 | 10 | mA |
| Experience Mempresses tribue | V _{DD} = 3.0 V | | 2.5 | 5 | mA |
| STOP: | V DD = 3.0 V | B | 2.0 | " | 11100 |
| Single-Chip Mode, No Clocks | $V_{DD} = 5.5 \text{ V}$ | SIDD | 50 | 50 | |
| Single-Crilp Mode, 140 Clocks | | | 25 | 25 | μA |
| | $V_{DD} = 3.0 \text{ V}$ | | 25 | 20 | μА |
| Maximum Power Dissipation | | P _D | | | |
| Single-Chip Mode | $V_{DD} = 5.5 \text{ V}$ | | 44 | 85 | mW |
| | $V_{DD} \approx 3.0 \text{ V}$ | | 12 | 24 | mW |
| Expanded Multiplexed Mode | $V_{DD} = 5.5 \text{ V}$ | | 77 | 150 | mW. |
| • | $V_{DD} = 3.0 \text{ V}$ | | 21 | 42 | mW |

NOTES:

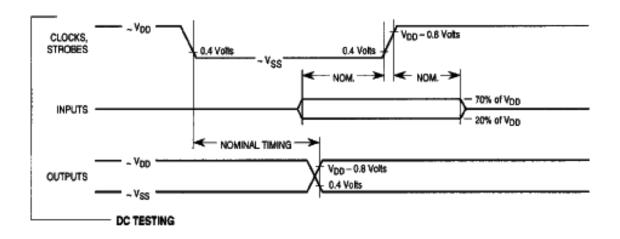
- V_{OH} specification for RESET and MODA is not applicable because they are open-drain pins. V_{OH} specification not applicable to ports C and D in wired-OR mode.
- 2. Refer to A/D specification for leakage current for port E.
- 3. EXTAL is driven with a square wave, and

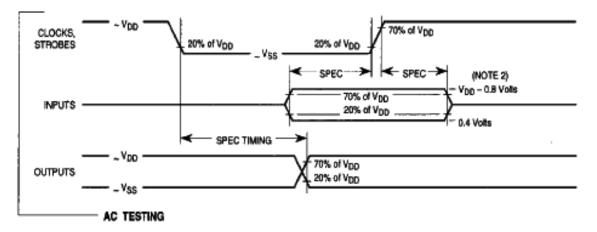
l_{cyc} = 1000 ns for 1 MHz rating;

 t_{CyC} = 500 ns for 2 MHz rating; $V_{\text{IL}} \le 0.2 \text{ V}$; $V_{\text{IH}} \ge V_{\text{DD}} - 0.2 \text{ V}$; No dc loads.

M68HC11 E SERIES

APPENDIX A TECHNICAL DATA ELECTRICAL CHARACTERISTICS MOTOROLA





NOTES:

- 1. Full test loads are applied during all DC electrical tests and AC timing measurements.
- During AC timing measurements, inputs are driven to 0.4 volts and V_{BD} = 0.8 volts while timing measurements are taken at the 20% and 70% of V_{DD} points.

TEST WET-4005 2

Figure A-1. Test Methods

MOTOROLA A-4 APPENDIX A
ELECTRICAL CHARACTERISTICS

Table A-4. Control Timing

 $V_{DD} = 5.0 \text{ Vdc} \pm 10\%$, $V_{SS} = 0 \text{ Vdc}$, $T_A = T_L \text{ to } T_H$

| Characteristic | Symbol | 1.0 | MHz | 2.0 | MHz | 3.0 | MHz | Unit |
|--|-------------------|------|-----|-----|-----|-----|------|------------------|
| | | Min | Max | Min | Max | Min | Max | |
| Frequency of Operation | 10 | dc | 1.0 | dc | 2.0 | dc | 3.0 | MHz |
| E-Clock Period | t _{cyc} | 1000 | _ | 500 | _ | 333 | _ | ns |
| Crystal Frequency | fXTAL | | 4.0 | | 8.0 | _ | 12.0 | MHz |
| External Oscillator Frequency | 4 fo | dc | 4.0 | dc | 8.0 | dc | 12.0 | MHz |
| Processor Control Setup Time tpcsu = 1/4 t _{cyc} + 50 ns | tpcsu | 300 | | 175 | - | 133 | - | ns |
| Reset Input Pulse Width To Guarantee External Reset Vector Minimum Input Time (Can Be Preempted by Internal Reset) | PWRSTL | 8 | _ | 8 | = | 8 | - | l _{cyc} |
| Mode Programming Setup Time | 1 _{MPS} | 2 | _ | 2 | _ | 2 | _ | t _{cyc} |
| Mode Programming Hold Time | [‡] MPH | 10 | | 10 | _ | 10 | _ | ns |
| Interrupt Pulse Width, IRQ Edge-Sensitive Mode PWIRQ = t _{cyc} + 20 ns | PWIRQ | 1020 | _ | 520 | | 353 | _ | ns |
| Wait Recovery Startup Time | twrs | _ | 4 | _ | 4 | _ | 4 | lcyc |
| Timer Pulse Width Input Capture Pulse Accumulator Input PWTIM = t _{CyC} + 20 ns | PW _{TIM} | 1020 | _ | 520 | · – | 353 | - | ns |

NOTES:

- RESET is recognized during the first clock cycle it is held low. Internal circuitry then drives the pin low for four clock cycles, releases the pin, and samples the pin level two cycles later to determine the source of the interrupt. Refer to SECTION 5 RESETS AND INTERRUPTS for further detail.
- All timing is shown with respect to 20% V_{DD} and 70% V_{DD}, unless otherwise noted.

M68HC11 E SERIES TECHNICAL DATA APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA A-5

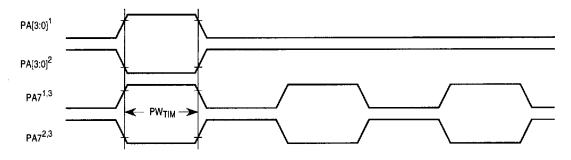
Table A-4a. Control Timing (MC68L11E9)

 V_{DD} = 3.0 Vdc to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Characteristic | Symbol | 1.0 | MHz | 2.0 | MHz | Unit |
|---|--------------------|------|-----|--------|----------|------------------|
| | | Min | Max | Min | Max | |
| Frequency of Operation | fo | dc | 1.0 | dc | 2.0 | MHz |
| E-Clock Period | t _{cyc} | 1000 | - | 500 | _ | ns |
| Crystal Frequency | fXTAL | _ | 4.0 | _ | 8.0 | MHz |
| External Oscillator Frequency | 4 f _o | dc | 4.0 | dc | 8.0 | MHz |
| Processor Control Setup Time tPCSU = 1/4 t _{CyC} + 75 ns | t _{PCSU} | 325 | _ | 200 | _ | ns |
| Reset Input Pulse Width To Guarantee External Reset Vector Minimum Input Time (Can Be Preempted by Internal Reset) | PW _{RSTL} | 8 | _ | 8 1 | <u> </u> | t _{cyc} |
| Mode Programming Setup Time | t _{MPS} | 2 | | 2 | _ | t _{cyc} |
| Mode Programming Hold Time | ^t MPH | 10 | _ | 10 | | ns |
| Interrupt Pulse Width, IRQ Edge-Sensitive Mode PWIRQ = t _{cyc} + 20 ns | PW _{IRQ} | 1020 | | 520 | _ | ns |
| Wait Recovery Startup Time | twrs | _ | 4 | _ | 4 | t _{cyc} |
| Timer Pulse Width, Input Capture Pulse Accumulator Input PW _{TIM} = t _{cyc} + 20 ns | PW _{TIM} | 1020 | _ | 520 | - | ns |

NOTES:

- RESET is recognized during the first clock cycle it is held low. Internal circuitry then drives the pin low for four clock cycles, releases the pin, and samples the pin level two cycles later to determine the source of the interrupt. Refer to SECTION 5 RESETS AND INTERRUPTS for further detail.
- 2. All timing is shown with respect to 20% V_{DD} and 70% V_{DD}, unless otherwise noted.



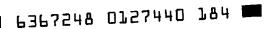
NOTES:

- 1. Rising edge sensitive input
- 2. Falling edge sensitive input
- 3. Maximum pulse accumulator clocking rate is E-clock frequency divided by 2.

TIMER INPUTS TIM

Figure A-2. Timer Inputs

MOTOROLA A-6 APPENDIX A
ELECTRICAL CHARACTERISTICS



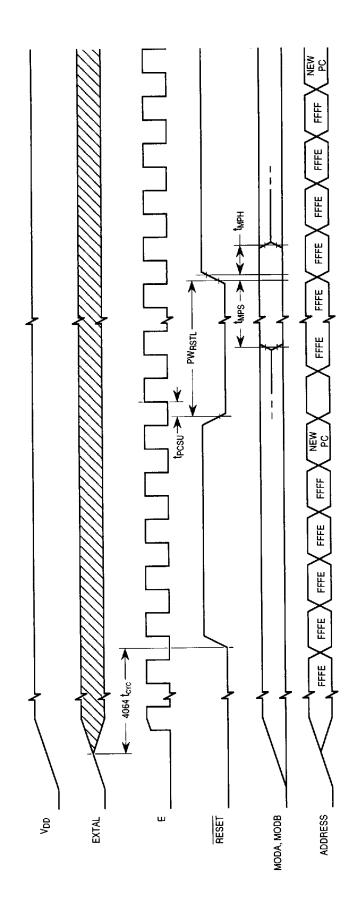


Figure A-3. POR External Reset Timing Diagram

POR EXT RESET TIM

M68HC11 E SERIES TECHNICAL DATA APPENDIX A ELECTRICAL CHARACTERISTICS

MOTOROLA A-7

■ 6367248 0127441 010 **■**

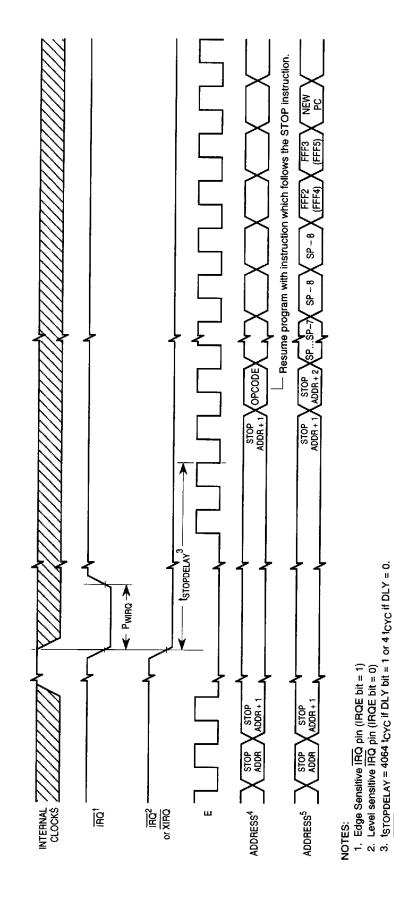


Figure A-4. STOP Recovery Timing Diagram

STOP RECOVERY TIM

MOTOROLA APPENDIX A **ELECTRICAL CHARACTERISTICS**

M68HC11 E SERIES **TECHNICAL DATA**

 \overline{XIRQ} with X bit in CCR = 1. \overline{IRQ} or \overline{XIRQ} with X bit in CCR = 0).

6367248 0127442 **T57**

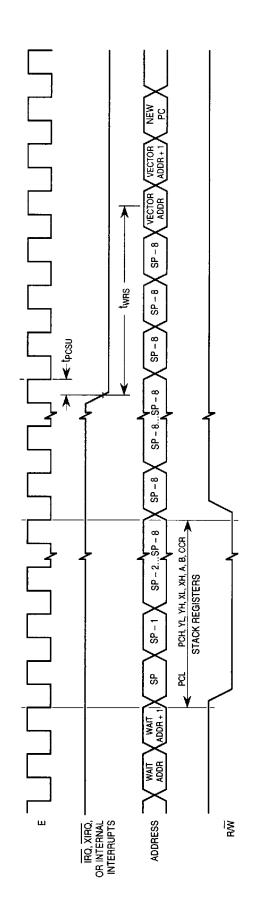


Figure A-5. WAIT Recovery from Interrupt Timing Diagram

WAIT RECOVERY TIM

NOTE: RESET also causes recovery from WAIT.

M68HC11 E SERIES TECHNICAL DATA APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA A-9

■ 6367248 0127443 993 ■

Figure A-6. Interrupt Timing Diagram

INTERRUPT TIM

MOTOROLA A-10 APPENDIX A ELECTRICAL CHARACTERISTICS

M68HC11 E SERIES TECHNICAL DATA

NOTES: 1. Edge sensitive $\overline{\text{IRQ}}$ pin (IRQE bit = 1) 2. Level sensitive $\overline{\text{IRQ}}$ pin (IRQE bit = 0)

■ 6367248 0127444 82T **■**

Table A-5. Peripheral Port Timing

 V_{DD} = 5.0 Vdc \pm 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Characteristic | Symbol | 1.0 | MHz | 2.0 | MHz | 3.0 | MHz | Unit | |
|---|-------------------|--------------|------------|-----|------------|-----|------------|----------|--|
| | | Min | Max | Min | Max | Min | Max | | |
| Frequency of Operation (E-Clock Frequency) | fo | dc | 1.0 | dc | 2.0 | dc | 3.0 | MHz | |
| E-Clock Period | t _{cyc} | 1000 | _ | 500 | | 333 | _ | ns | |
| Peripheral Data Setup Time MCU Read of Ports A, C, D, and E | t _{PDSU} | 100 | _ | 100 | | 100 | | ns | |
| Peripheral Data Hold Time MCU Read of Ports A, C, D, and E | t _{PDH} | 50 | _ | 50 | _ | 50 | _ | ns | |
| Delay Time, Peripheral Data Write MCU Write to Port A MCU Writes to Ports B, C, and D tpwD = 1/4 t _{cyc} + 100 ns | t _{PWD} | - | 200 350 | _ | 200 225 | _ | 200 183 | ns ns | |
| Input Data Setup Time (Port C) | t _{IS} | 60 | _ | 60 | | 60 | _ | ns | |
| Input Data Hold Time (Port C) | t _{IH} | 100 | _ | 100 | _ | 100 | _ | ns | |
| Delay Time, E Fall to STRB t _{DEB} = 1/4 t _{cyc} + 100 ns | t _{DEB} | _ | 350 | _ | 225 | | 183 | ns | |
| Setup Time, STRA Asserted to E Fall (Note 1) | tAES | 0 | _ | 0 | _ | 0 | _ | ns | |
| Delay Time, STRA Asserted to Port C Data Output Valid | t _{PCD} | _ | 100 | _ | 100 | _ | 100 | ns | |
| Hold Time, STRA Negated to Port C Data | ^t PCH | 10 | _ | 10 | _ | 10 | _ | ns | |
| Three-State Hold Time | tPCZ | _ | 150 | _ | 150 | | 150 | ns | |

NOTES:

- 1. If this setup time is met, STRB acknowledges in the next cycle. If it is not met, the response may be delayed one more cycle.
- 2. Port C and D timing is valid for active drive (CWOM and DWOM bits not set in PIOC and SPCR registers respectively).
- 3. All timing is shown with respect to 20% V_{DD} and 70% V_{DD} , unless otherwise noted.

M68HC11 E SERIES
TECHNICAL DATA

APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA

Table A-5a. Peripheral Port Timing (MC68L11E9)

 V_{DD} = 3.0 Vdc to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Characteristic | Symbol | 1.0 | MHz | 2.0 | Unit | |
|--|-------------------|----------|------------|----------|------------|----------|
| | | Min | Max | Min | Max | |
| Frequency of Operation (E-Clock Frequency) | fo | dc | 1.0 | dc | 2.0 | MHz |
| E-Clock Period | t _{cyc} | 1000 | | 500 | _ | ns |
| Peripheral Data Setup Time MCU Read of Ports A, C, D, and E | ^t PDSU | 100 | _ | 100 | _ | ns |
| Peripheral Data Hold Time MCU Read of Ports A, C, D, and E | tPDH | 50 | | 50 | _ | ns |
| Delay Time, Peripheral Data Write MCU Write to Port A MCU Writes to Ports B, C, and D $t_{PWD} = 1/4\ t_{cyc} + 150\ ns$ | tPWD | <u>-</u> | 250 400 | <u> </u> | 250 275 | ns ns |
| Input Data Setup Time (Port C) | t _{IS} | 60 | _ | 60 | _ | ns |
| input Data Hold Time (Port C) | ŧн | 100 | _ | 100 | _ | ns |
| Delay Time, E Fall to STRB t _{DEB} = 1/4 t _{cyc} + 150 ns | t _{DEB} | _ | 400 | _ | 275 | ns |
| Setup Time, STRA Asserted to E Fall (Note 1) | t _{AES} | 0 | | 0 | _ | ns |
| Delay Time, STRA Asserted to Port C Data Output Valid | tPCD | _ | 100 | | 100 | ns |
| Hold Time, STRA Negated to Port C Data | tpch | 10 | | 10 | _ | ns |
| Three-State Hold Time | tPCZ | _ | 150 | _ | 150 | ns |

NOTES:

- If this setup time is met, STRB acknowledges in the next cycle. If it is not met, the response may be delayed one more cycle.
- Port C and D timing is valid for active drive (CWOM and DWOM bits not set in PIOC and SPCR registers respectively).
- 3. All timing is shown with respect to 20% V_{DD} and 70% V_{DD} , unless otherwise noted.

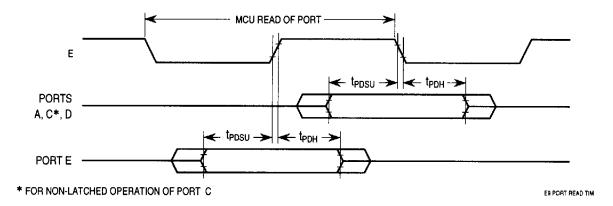


Figure A-7. Port Read Timing Diagram

MOTOROLA A-12 APPENDIX A
ELECTRICAL CHARACTERISTICS

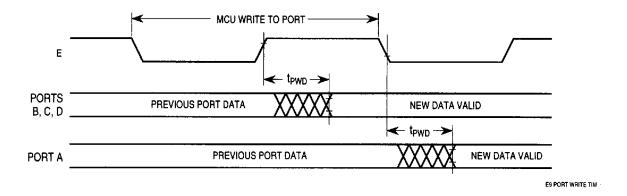
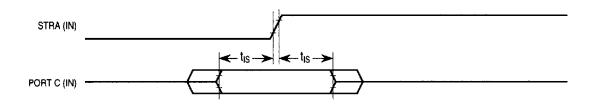


Figure A-8. Port Write Timing Diagram



SIMPLE INPUT STROBE TIM

Figure A-9. Simple Input Strobe Timing Diagram

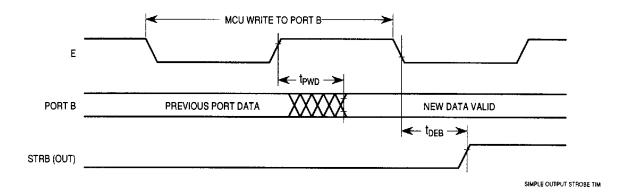
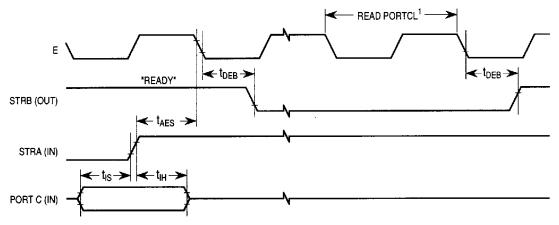


Figure A-10. Simple Output Strobe Timing Diagram

M68HC11 E SERIES TECHNICAL DATA APPENDIX A ELECTRICAL CHARACTERISTICS

MOTOROLA A-13

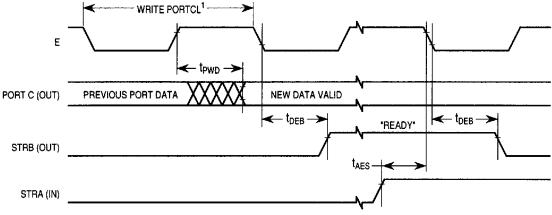


NOTES:

- 1. After reading PIOC with STAF set
- 2. Figure shows rising edge STRA (EGA = 1) and high true STRB (INVB = 1).

PORT C INPUT HNDSHK TIM

Figure A-11. Port C Input Handshake Timing Diagram

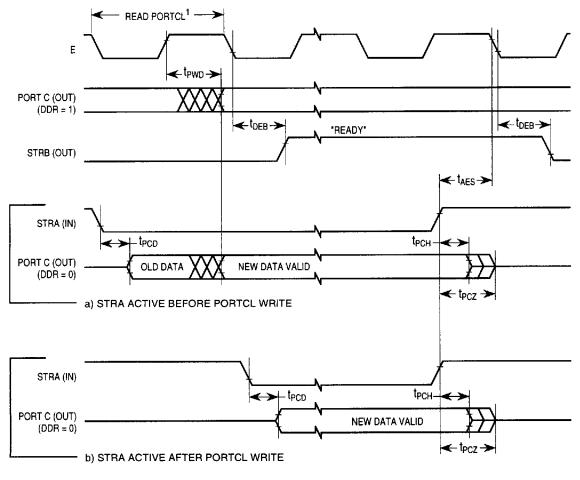


- NOTES:
- 1. After reading PIOC with STAF set
- 2. Figure shows rising edge STRA (EGA = 1) and high true STRB (INVB = 1).

PORT COUTPUT HNDSHK TIM

Figure A-12. Port C Output Handshake Timing Diagram

MOTOROLA A-14 APPENDIX A
ELECTRICAL CHARACTERISTICS



NOTES:

- 1. After reading PIOC with STAF set
- 2. Figure shows rising edge STRA (EGA = 1) and high true STRB (INVB = 1).

3-STATE VAR OUTPUT HNDSHK TIM

Figure A-13. Three-State Variation of Output Handshake Timing Diagram (STRA Enables Output Buffer)

M68HC11 E SERIES TECHNICAL DATA APPENDIX A ELECTRICAL CHARACTERISTICS

MOTOROLA A-15

Table A-6. Analog-To-Digital Converter Characteristics

 $V_{DD} = 5.0 \text{ Vdc} \pm 10\%, \ V_{SS} = 0 \text{ Vdc}, \ T_A = T_L \text{ to } T_{H_1}, 750 \text{ kHz} \leq E \leq 3.0 \text{ MHz}, \text{ unless otherwise noted}$

| Characteristic | Parameter | Min | Absolute | 2.0 MHz | 3.0 MHz | Unit |
|----------------------------|---|----------------------|-------------|-----------------------|-----------------------|------------------|
| | | | | Max | Max | |
| Resolution | Number of Bits Resolved by A/D Converter | | 8 | | | Bits |
| Non-Linearity | Maximum Deviation from the Ideal A/D Transfer Characteristics | | _ | ± 1/2 | ±1 | LSB |
| Zero Error | Difference Between the Output of an Ideal and an Actual for Zero Input Voltage | _ | _ | ± 1/2 | ± 1 | LSB |
| Full Scale Error | Difference Between the Output of an Ideal and an Actual A/D for Full-Scale Input Voltage | _ | _ | ± 1/2 | ±1 | LSB |
| Total Unadjusted Error | Maximum Sum of Non-Linearity, Zero Error, and Full-Scale Error | _ | | ± 1/2 | ± 1 1/2 | LSB |
| Quantization Error | Uncertainty Because of Converter Resolution | _ | _ | ± 1/2 | ± 1/2 | LSB |
| Absolute Accuracy | Difference Between the Actual Input Voltage and the Full-Scale Weighted Equivalent of the Binary Output Code, All Error Sources Included | _ | | ±1 | ±2 | LSB |
| Conversion Range | Analog Input Voltage Range | V _{RL} | _ | V _{RH} | V _{RH} | ٧ |
| V _{RH} | Maximum Analog Reference Voltage (Note 2) | V _{RL} | _ | V _{DD} + 0.1 | V _{DD} + 0.1 | ٧ |
| V _{RL} | Minimum Analog Reference Voltage (Note 2) | V _{SS} -0.1 | _ | V _{RH} | V _{RH} | ٧ |
| ΔV _R | Minimum Difference between V _{RH} and V _{RL} (Note 2) | 3 | _ | _ | _ | ٧ |
| Conversion Time | Total Time to Perform a Single Analog-to-Digital Conversion: | | | | | |
| | E Clock | | 32 | _ | | t _{cyc} |
| | Internal RC Oscillator | _ | _ | t _{cyc} + 32 | t _{cyc} + 32 | μs |
| Monotonicity | Conversion Result Never Decreases with an Increase in Input Voltage and has no Missing Codes | | Guaranteed | | | |
| Zero Input Reading | Conversion Result when V _{in} = V _{RL} | 00 | | | <u>—</u> | Hex |
| Full Scale Reading | Conversion Result when V _{in} = V _{RH} | _ | _ | FF · | FF | Hex |
| Sample | Analog Input Acquisition Sampling Time: | | | , teli aar isi b | | |
| Acquisition Time | E Clock | _ | 12 | _ | _ | t _{cyc} |
| | Internal RC Oscillator | _ | _ | 12 | 12 | μs |
| Sample/Hold Capacitance | Input Capacitance During Sample PE[7:0] | _ | 20 (Тур) | _ | _ | рF |
| Input Leakage | Input Leakage on A/D Pins PE[7:0] | | _ | 400 | 400 | nΑ |
| | V_{RL} , V_{RH} | | _ 7 | 1.0 | 1.0 | μ Α |

NOTES:

- 1. Source impedances greater than 10 $k\Omega$ affect accuracy adversely because of input leakage.
- 2. Performance verified down to 2.5 V Δ V_R, but accuracy is tested and guaranteed at Δ V_R = 5 V \pm 10%.

MOTOROLA

APPENDIX A

M68HC11 E SERIES
TECHNICAL DATA

A-16

ELECTRICAL CHARACTERISTICS

Table A-6a. Analog-To-Digital Converter Characteristics (MC68L11E9)

 V_{DD} = 3.0 Vdc to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_{H_1} 750 kHz \leq E \leq 2.0 MHz, unless otherwise noted

| Characteristic | Parameter | Min | Absolute | Max | Unit | |
|----------------------------|--|----------------------|------------|-----------------------|------------------|--|
| Resolution | Number of Bits Resolved by A/D Converter | _ | 8 | _ | Bits | |
| Non-Linearity | Maximum Deviation from the Ideal A/D Transfer Characteristics | | _ | ±1 | LSB | |
| Zero Error | Difference Between the Output of an Ideal and an Actual for Zero Input Voltage | _ | _ | ±1 | LSB | |
| Full Scale Error | Difference Between the Output of an Ideal and an Actual A/D for Full-Scale Input Voltage | _ | _ | ±1 | LSB | |
| Total Unadjusted Error | Maximum Sum of Non-Linearity, Zero Error, and Full-Scale Error | · _ | _ | ± 1 1/2 | LSB | |
| Quantization Error | Uncertainty Because of Converter Resolution | <u>—</u> | _ | ± 1/2 | LSB | |
| Absolute Accuracy | | _ | ±2 | LSB | | |
| Conversion Range | Analog Input Voltage Range | V _{RL} | _ | V _{RH} | ٧ | |
| V _{RH} | Maximum Analog Reference Voltage | V _{RL} | _ | V _{DD} + 0.1 | ٧ | |
| V _{RL} | Minimum Analog Reference Voltage | V _{SS} -0.1 | | V _{RH} | ٧ | |
| ΔVR | Minimum Difference between V _{RH} and V _{RL} | 3.0 | _ | | ٧ | |
| Conversion Time | Total Time to Perform a Single Analog-to-Digital Conversion: | | | | | |
| | E Clock | | 32 | | t _{cyc} | |
| | Internal RC Oscillator | _ | _ | t _{cyc} + 32 | μs | |
| Monotonicity | Conversion Result Never Decreases with an Increase in Input Voltage and has no Missing Codes | _ | Guaranteed | _ | | |
| Zero Input Reading | Conversion Result when V _{in} = V _{RL} | 00 | _ | _ | Hex | |
| Full Scale Reading | Conversion Result when V _{in} = V _{RH} | _ | _ | FF | Hex | |
| Sample | Analog Input Acquisition Sampling Time: | | | | · | |
| Acquisition Time | E Clock | | 12 | _ | t _{cyc} | |
| | Internal RC Oscillator | _ | _ | 12 | μs | |
| Sample/Hold Capacitance | Input Capacitance During Sample PE[7:0] | _ | 20 (Typ) | _ | pF | |
| Input Leakage | Input Leakage on A/D Pins PE[7:0] | _ | | 400 | nA | |
| | V _{RL} , V _{RH} | | | 1.0 | μА | |

NOTES:

1. Source impedances greater than 10 k Ω affect accuracy adversely because of input leakage.

M68HC11 E SERIES

APPENDIX A TECHNICAL DATA ELECTRICAL CHARACTERISTICS **MOTOROLA**

Table A-7. Expansion Bus Timing

 V_{DD} = 5.0 Vdc \pm 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Num | Characteristic | Symbol | 1.0 | MHz | 2.0 | MHz | 3.0 | MHz | Unit |
|----------|---|-------------------|-------|----------|-----|----------|-----|----------|------|
| | | - | Min | Max | Min | Max | Min | Max | |
| | Frequency of Operation (E-Clock Frequency) | fo | dc | 1.0 | dc | 2.0 | dc | 3.0 | MHz |
| 1 | Cycle Time | t _{cyc} | 1000 | _ | 500 | _ | 333 | _ | ns |
| 2 | Pulse Width, E Low PW _{EL} = 1/2 t _{CVC} - 23 ns (Note 1) | PW _{EL} | 477 | _ | 227 | | 146 | _ | ns |
| 3 | Pulse Width, E High PW _{EH} = 1/2 t _{cyc} – 28 ns (Note 1) | PWEH | 472 | | 222 | _ | 141 | | ns |
| 4a 4b | E and AS Rise Time E and AS Fall Time | t _r | | 20 20 | | 20 20 | _ | 20 15 | ns |
| 9 | Address Hold Time t _{AH} = 1/8 t _{cyc} – 29.5 ns (Note 1, 2a) | t _{AH} | 95.5 | _ | 33 | | 26 | _ | ns |
| 12 | Nonmultiplexed Address Valid Time to E Rise $t_{AV} = PW_{EL} - (t_{ASD} + 80 \text{ ns}) \text{ (Note 1, 2a)}$ | t _{AV} | 281.5 | _ | 94 | | 54 | _ | ns |
| 17 | Read Data Setup Time | tDSR | 30 | | 30 | - | 30 | | ns |
| 18 | Read Data Hold Time (Max = t _{MAD}) | tDHR | 0 | 145.5 | 0 | 83 | 0 | 51 | ns |
| 19 | Write Data Delay Time t _{DDW} = 1/8 t _{cyc} + 65.5 ns (Note 1, 2a) | t _{DDW} | _ | 190.5 | _ | 128 | | 71 | ns |
| 21 | Write Data Hold Time t _{DHW} = 1/8 t _{cyc} - 29.5 ns (Note 1, 2a) | tDHW | 95.5 | _ | 33 | _ | 26 | _ | ns |
| 22 | Multiplexed Address Valid Time to E Rise t _{AVM} = PW _{EL} - (t _{ASD} + 90 ns) (Note 1, 2a) | tAVM | 271.5 | _ | 84 | | 54 | | ns |
| 24 | Multiplexed Address Valid Time to AS Fall t _{ASL} = PW _{ASH} - 70 ns (Note 1) | tasl | 151 | | 26 | _ | 13 | _ | ns |
| 25 | Multiplexed Address Hold Time t _{AHL} = 1/8 t _{cyc} - 29.5 ns (Note 1, 2b) | tAHL | 95.5 | _ | 33 | _ | 31 | | ns |
| 26 | Delay Time, E to AS Rise t _{ASD} = 1/8 t _{cyc} - 9.5 ns (Note 1, 2a) | t _{ASD} | 115.5 | _ | 53 | | 31 | | ns |
| 27 | Pulse Width, AS High PW _{ASH} = 1/4 t _{cyc} – 29 ns (Note 1) | PWASH | 221 | _ | 96 | _ | 63 | _ | ns |
| 28 | Delay Time, AS to E Rise t _{ASED} = 1/8 t _{cyc} - 9.5 ns (Note 1, 2b) | tASED | 115.5 | _ | 53 | _ | 31 | _ | ns |
| 29 | MPU Address Access Time (Note 2a) tACCA = t _{cyc} - (PW _{EL} - t _{AVM}) - t _{DSR} -t _f | [†] ACCA | 744.5 | _ | 307 | | 196 | | ns |
| 35 | MPU Access Time tACCE = PWEH - tDSR | t _{ACCE} | — | 442 | _ | 192 | | 111 | ns |
| 36 | Multiplexed Address Delay (Previous Cycle MPU Read) t _{MAD} = t _{ASD} + 30 ns (Note 1, 2a) | t _{MAD} | 145.5 | | 83 | _ | 51 | _ | ns |

NOTES:

- 1. Formula only for dc to 2 MHz.
- Input clocks with duty cycles other than 50% affect bus performance. Timing parameters affected by input clock duty cycle are identified by (a) and (b). To recalculate the approximate bus timing values, substitute the following expressions in place of 1/8 t_{cyc} in the above formulas, where applicable:
 - (a) $(1-DC) \times 1/4 t_{cyc}$
 - (b) DC \times 1/4 t_{cyc}

Where:

DC is the decimal value of duty cycle percentage (high time).

3. All timing is shown with respect to 20% V_{DD} and 70% V_{DD}, unless otherwise noted.

MOTOROLA A-18 APPENDIX A
ELECTRICAL CHARACTERISTICS

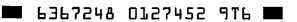


Table A-7a. Expansion Bus Timing (MC68L11E9)

 V_{DD} = 3.0 Vdc to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Num | Characteristic | | Symbol | 1.0 | 1.0 MHz | | 2.0 MHz | |
|----------|--|-----------|----------------------------------|------|----------|-----|----------|----------|
| | | | | Min | Max | Min | Max | 1 |
| | Frequency of Operation (E-Clock Frequency) | | fo | dc | 1.0 | dc | 2.0 | MHz |
| 1 | Cycle Time | | t _{cyc} | 1000 | _ | 500 | _ | ns |
| 2 | Pulse Width, E Low PW _{EL} = 1/2 t _{cyc} – 25 ns | | PW _{EL} | 475 | _ | 225 | _ | ns |
| 3 | Pulse Width, E High PW _{EH} = 1/2 t _{cyc} – 30 ns | | PW _{EH} | 470 | _ | 220 | _ | ns |
| 4A 4B | E and AS Rise Time E and AS Fall Time | | t _r t _f | _ | 25 25 | _ | 25 25 | ns ns |
| 9 | Address Hold Time t _{AH} = 1/8 t _{cyc} – 30 ns | (Note 1a) | ^t AH | 95 | | 33 | _ | ns |
| 12 | Nonmultiplexed Address Valid Time to E Rise t _{AV} = PW _{EL} - (t _{ASD} + 80 ns) | (Note 1a) | t _{AV} | 275 | | 88 | | ns |
| 17 | Read Data Setup Time | | tDSR | 30 | | 30 | _ | ns |
| 18 | Read Data Hold Time (Max = t _{MAD}) | | tDHR | 0 | 150 | 0 | 88 | ns |
| 19 | Write Data Delay Time t _{DDW} = 1/8 t _{cyc} + 70 ns | (Note 1a) | toow | _ | 195 | _ | 133 | ns |
| 21 | Write Data Hold Time t _{DHW} = 1/8 t _{cyc} - 30 ns | (Note 1a) | tDHW | 95 | | 33 | | ns |
| 22 | Multiplexed Address Valid Time to E Rise $t_{\text{AVM}} = \text{PW}_{\text{EL}} - (t_{\text{ASD}} + 90 \text{ ns})$ | (Note 1a) | [†] AVM | 265 | | 78 | | ns |
| 24 | Multiplexed Address Valid Time to AS Fall t _{ASL} = PW _{ASH} - 70 ns | | †ASL | 150 | | 25 | _ | ns |
| 25 | Multiplexed Address Hold Time t _{AHL} = 1/8 t _{cyc} - 30 ns | (Note 1b) | ^t AHL | 95 | | 33 | | ns |
| 26 | Delay Time, E to AS Rise t _{ASD} = 1/8 t _{cyc} – 5 ns | (Note 1a) | tasd | 120 | | 58 | _ | ns |
| 27 | Pulse Width, AS High PW _{ASH} = 1/4 t _{cyc} – 30 ns | | PW _{ASH} | 220 | | 95 | _ | ns |
| 28 | Delay Time, AS to E Rise t _{ASED} = 1/8 t _{cyc} – 5 ns | (Note 1b) | ^t ASED | 120 | | 58 | _ | ns |
| 29 | MPU Address Access Time tACCA = t _{cyc} - (PW _{EL} -t _{AVM}) - t _{DSR} -t _f | (Note 1a) | [†] ACCA | 735 | _ | 298 | _ | ns |
| 35 | MPU Access Time tacce = PWEH - tdsR | | †ACCE | _ | 440 | _ | 190 | ns |
| 36 | Multiplexed Address Delay (Previous Cycle MPU Read) t _{MAD} = t _{ASD} + 30 ns | (Note 1a) | ^t MAD | 150 | _ | 88 | - | ns |

NOTES:

 Input clocks with duty cycles other than 50% affect bus performance. Timing parameters affected by input clock duty cycle are identified by (a) and (b). To recalculate the approximate bus timing values, substitute the following expressions in place of 1/8 t_{cyc} in the above formulas, where applicable:

(a) $(1-DC) \times 1/4 t_{CVC}$

(b) DC \times 1/4 t_{cyc}

Where:

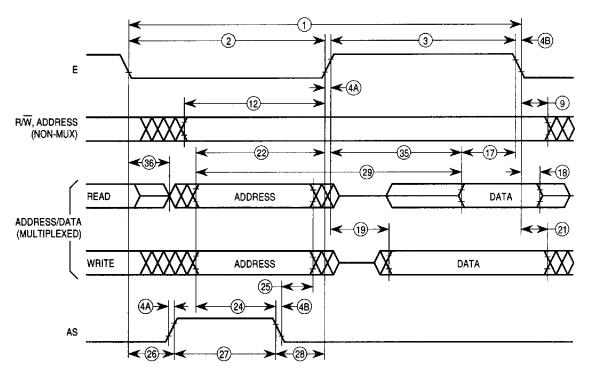
DC is the decimal value of duty cycle percentage (high time).

2. All timing is shown with respect to 20% V_{DD} and 70% V_{DD} , unless otherwise noted.

M68HC11 E SERIES TECHNICAL DATA APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA A-19

| 6367248 0127453 832 🖿



NOTE: Measurement points shown are 20% and 70% of V_{DD}.

MUX BUS TIM

Figure A-14. Multiplexed Expansion Bus Timing Diagram

MOTOROLA A-20 APPENDIX A
ELECTRICAL CHARACTERISTICS

Table A-8. Serial Peripheral Interface Timing

 V_{DD} = 5.0 Vdc \pm 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Num | Characteristic | Symbol | 2.0 MHz | | 3.0 MHz | | Unit |
|-----|---|--|------------|------------|------------|------------|------------------------|
| | | | Min | Max | Min | Max | |
| | Operating Frequency Master Slave | f _{op(m)} f _{op(s)} | dc dc | 0.5 2.0 | dc dc | 0.5 3.0 | f _{op} MHz |
| 1 | Cycle Time Master Slave | t _{cyc(m)} | 2.0 500 | _ | 2.0 333 | _ | t _{cyc} |
| 2 | Enable Lead Time Master (Note 2) Slave | ^t lead(m) ^t lead(s) | 250 | | 240 | _ | ns ns |
| 3 | Enable Lag Time Master (Note 2) Slave | t _{lag(m)} | 250 | | 240 | _ | ns ns |
| 4 | Clock (SCK) High Time Master Slave | t _w (SCKH)m t _w (SCKH)s | 340 190 | _ | 227 127 | _ | ns ns |
| 5 | Clock (SCK) Low Time Master Slave | tw(SCKL)m | 340 190 | _ | 227 127 | _ | ns ns |
| 6 | Data Setup Time (Inputs) Master Slave | t _{su(m)} t _{su(s)} | 100 100 | _ | 100 100 | _ | ns ns |
| 7 | Data Hold Time (Inputs) Master Slave | t _{h(m)} | 100 100 | | 100 100 | _ | ns ns |
| 8 | Access Time (Time to Data Active from High-Impedance State) Slave | ta | 0 | 120 | 0 | 120 | ns |
| 9 | Disable Time (Hold Time to High-Impedance State) Slave | t _{dis} | _ | 240 | | 167 | ns |
| 10 | Data Valid (After Enable Edge) (Note 3) | t _{v(s)} | _ | 240 | | 167 | ns |
| 11 | Data Hold Time (Outputs) (After Enable Edge) | t _{ho} | 0 | _ | 0 | _ | ns |
| 12 | Rise Time (20% V _{DD} to 70% V _{DD} , C _L = 200 pF) SPI Outputs (SCK, MOSI, and MISO) SPI Inputs (SCK, MOSI, MISO, and SS) | t _{rm} | | 100 2.0 | _ | 100 2.0 | ns µs |
| 13 | Fall Time (70% V _{DD} to 20% V _{DD} , C _L = 200 pF) SPI Outputs (SCK, MOSI, and MISO) SPI Inputs (SCK, MOSI, MISO, and SS) | t _{fm} | | 100 2.0 | _ | 100 2.0 | ns µs |

NOTES:

- 1. All timing is shown with respect to 20% $\rm V_{DD}$ and 70% $\rm V_{DD}$, unless otherwise noted.
- 2. Signal production depends on software.
- 3. Assumes 200 pF load on SCK, MOSI, and MISO pins.

M68HC11 E SERIES TECHNICAL DATA APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA

Table A-8a. Serial Peripheral Interface Timing (MC68L11E9)

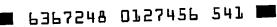
 V_{DD} = 3.0 Vdc to 5.5 Vdc, V_{SS} = 0 Vdc, T_{A} = T_{L} to T_{H}

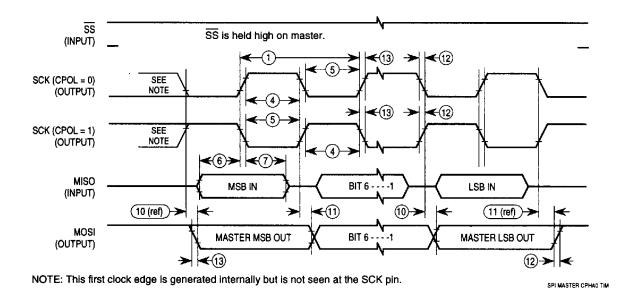
| Num | Characteristic | Symbol | 1.0 | 1.0 MHz | | 2.0 MHz | |
|-----|---|--|-------------|------------|------------|------------|------------------------|
| | | | Min | Max | Min | Max | |
| | Operating Frequency Master Slave | f _{op(m)} f _{op(s)} | dc dc | 0.5 1.0 | dc dc | 0.5 2.0 | f _{op} MHz |
| 1 | Cycle Time Master Slave | t _{cyc(m)} | 2.0 1000 | _ | 2.0 500 | | t _{cyc} ns |
| 2 | Enable Lead Time Master (Note 2) Slave | ^t lead(m) ^t lead(s) | 500 | | _ 250 | _ | ns ns |
| 3 | Enable Lag Time Master (Note 2) Slave | t _{lag(m)} t _{lag(s)} | 500 | _ | 250 | _ | ns ns |
| 4 | Clock (SCK) High Time Master Slave | tw(SCKH)m | 680 380 | | 340 190 | _ | ns ns |
| 5 | Clock (SCK) Low Time Master Slave | tw(SCKL)m tw(SCKL)s | 680 380 | <u> </u> | 340 190 | _ | ns ns |
| 6 | Data Setup Time (Inputs) Master Slave | t _{su(m)} t _{su(s)} | 100 100 | _ | 100 100 | _ | ns ns |
| 7 | Data Hold Time (Inputs) Master Slave | t _{h(m)} | 100 100 | _ | 100 100 | _ | ns ns |
| 8 | Access Time (Time to Data Active from High-Imp. State) Slave | ta | 0 | 120 | 0 | 120 | ns |
| 9 | Disable Time (Hold Time to High-Impedance State) Slave | [‡] dis | _ | 240 | _ | 240 | ns |
| 10 | Data Valid (After Enable Edge) (Note 3) | t _{v(s)} | _ | 240 | _ | 240 | ns |
| 11 | Data Hold Time (Outputs) (After Enable Edge) | t _{ho} | 0 | _ | 0 | _ | ns |
| 12 | Rise Time (20% V _{DD} to 70% V _{DD} , C _L = 200 pF) SPI Outputs (SCK, MOSI, and MISO) SPI Inputs (SCK, MOSI, MISO, and SS) | t _{rm} | | 100 2.0 | _ | 100 2.0 | ns µs |
| 13 | Fall Time (70% V _{DD} to 20% V _{DD} , C _L = 200 pF) SPI Outputs (SCK, MOSI, and MISO) SPI Inputs (SCK, MOSI, MISO, and SS) | t _{fm} | _ | 100 2.0 | _ | 100 2.0 | ns µs |

NOTES:

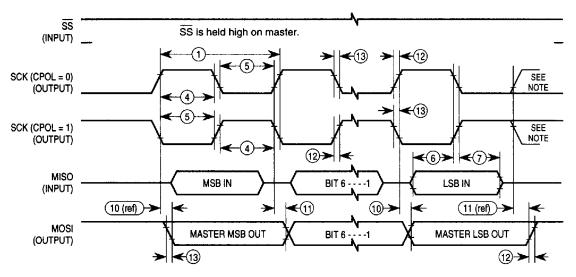
- 1. All timing is shown with respect to 20% $\rm V_{DD}$ and 70% $\rm V_{DD}$, unless otherwise noted.
- 2. Signal production depends on software.
- 3. Assumes 100 pF load on all SPI pins.

MOTOROLA A-22 APPENDIX A
ELECTRICAL CHARACTERISTICS





a) SPI Master Timing (CPHA = 0)



NOTE: This last clock edge is generated internally but is not seen at the SCK pin.

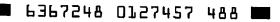
SPI MASTER CPHA1 TIM

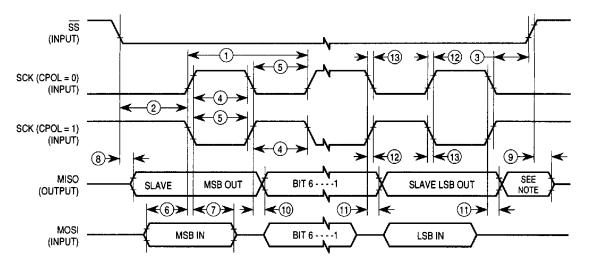
b) SPI Master Timing (CPHA = 1)

Figure A-15. SPI Timing Diagram (1 of 2)

M68HC11 E SERIES TECHNICAL DATA APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA A-23

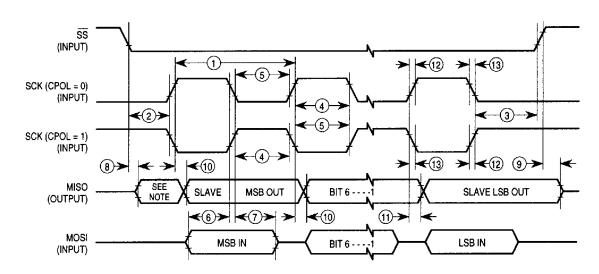




NOTE: Not defined but normally MSB of character just received.

SPI SLAVE CPHA0 TIM

a) SPI Slave Timing (CPHA = 0)



NOTE: Not defined but normally LSB of character previously transmitted.

SPI SLAVE CPHA1 TIM

b) SPI Slave Timing (CPHA = 1)

Figure A-15. SPI Timing Diagram (2 of 2)

MOTOROLA A-24 APPENDIX A
ELECTRICAL CHARACTERISTICS

M68HC11 E SERIES TECHNICAL DATA

= 6367248 0127458 314 **=**

Table A-9. EEPROM Characteristics

 $V_{DD} = 5.0 \text{ Vdc} \pm 10\%$, $V_{SS} = 0 \text{ Vdc}$, $T_A = T_L \text{ to } T_H$

| Characteristic | Temperature Range | | | | |
|---|-------------------|--------------------------|--------------------------|--------|--|
| | - 40 to 85° C | – 40 to 105° C | – 40 to 125° C | | |
| Programming Time <1.0 MHz, RCO Enabled (Note 1) 1.0 to 2.0 MHz, RCO Enabled ≥2.0 MHz (or Anytime RCO Enabled) | 10 20 10 | 15 Must use RCO 15 | 20 Must use RCO 20 | ms | |
| Erase Time (Note 1) Byte, Row and Bulk | 10 | 10 | 10 | ms | |
| Write/Erase Endurance (Note 2) | 10,000 | 10,000 | 10,000 | Cycles | |
| Data Retention (Note 2) | 10 | 10 | 10 | Years | |

NOTES:

- The RC oscillator (RCO) must be enabled (by setting the CSEL bit in the OPTION register) for EEPROM
 programming and erasure when the E-clock frequency is below 1.0 MHz.
- 2. Refer to Reliability Monitor Report (current quarterly issue) for current failure rate information.

Table A-9a. EEPROM Characteristics (MC68L11E9)

 V_{DD} = 3.0 Vdc to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H

| Charac | Temperature Range – 20 to 70° C | Unit | |
|---|--|----------|----------|
| Programming Time (Note 1) | 3 V, E ≤ 2.0 MHz, RCO Enabled 5 V, E ≤ 2.0 MHz, RCO Enabled | 25 10 | ms ms |
| Erase Time (Byte, Row and Bulk) (Note 1) | 3 V, E ≤ 2.0 MHz, RCO Enabled 5 V, E ≤ 2.0 MHz, RCO Enabled | 25 10 | ms ms |
| Write/Erase Endurance (Note 2) | | 10,000 | Cycles |
| Data Retention (Note 2) | | 10 | Years |

NOTES:

- 1. The RC oscillator (RCO) must be enabled (by setting the CSEL bit in the OPTION register) for EEPROM programming and erasure.
- 2. Refer to Reliability Monitor Report (current quarterly issue) for current failure rate information.

M68HC11 E SERIES TECHNICAL DATA APPENDIX A
ELECTRICAL CHARACTERISTICS

MOTOROLA A-25

6367248 0127459 250 📟